

# 2SK3550-01R

**FUJI POWER MOSFET**

**N-CHANNEL SILICON POWER MOSFET**

## Super FAP-G Series

### ■ Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- Avalanche-proof

### ■ Applications

- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters

### ■ Maximum ratings and characteristic Absolute maximum ratings

● (Tc=25°C unless otherwise specified)

Item	Symbol	Ratings	Unit
Drain-source voltage	V <sub>DS</sub>	900	V
	V <sub>D SX</sub> *5	900	V
Continuous drain current	I <sub>D</sub>	±10	A
Pulsed drain current	I <sub>D(puls)</sub>	±40	A
Gate-source voltage	V <sub>GS</sub>	±30	V
Repetitive or non-repetitive	I <sub>AR</sub> *2	10	A
Maximum Avalanche Energy	E <sub>AS</sub> *1	330	mJ
Maximum Drain-Source dV/dt	dV <sub>DS</sub> /dt *4	40	kV/μs
Peak Diode Recovery dV/dt	dV/dt *3	5	kV/μs
Max. power dissipation	P <sub>D</sub>	T <sub>a</sub> =25°C	3.13
		T <sub>c</sub> =25°C	130
Operating and storage temperature range	T <sub>ch</sub>	+150	°C
	T <sub>stg</sub>	-55 to +150	°C
Isolation Voltage	V <sub>ISO</sub> *6	2	kVrms

\*1 L=6.06mH, V<sub>CC</sub>=90V, T<sub>ch</sub>=25°C, See to Avalanche Energy Graph \*2 T<sub>ch</sub>≤150°C

\*3 I<sub>F</sub>≤-I<sub>D</sub>, -di/dt=50A/μs, V<sub>CC</sub>≤BV<sub>DSS</sub>, T<sub>ch</sub>≤150°C \*4 V<sub>DS</sub>≤900V \*5 V<sub>GS</sub>=-30V \*6 t=60sec, f=60Hz

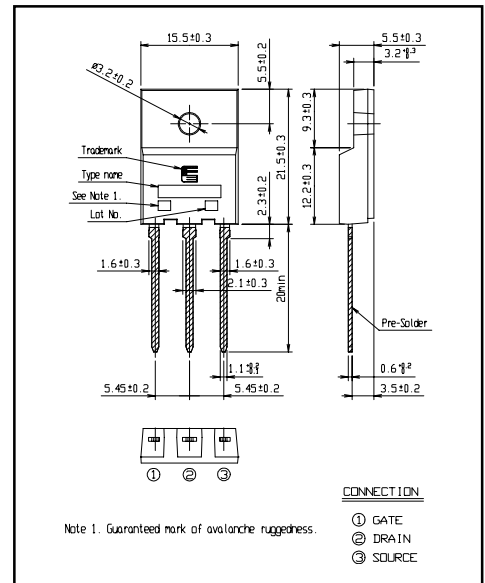
### ● Electrical characteristics (Tc =25°C unless otherwise specified)

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	I <sub>D</sub> =250μA V <sub>GS</sub> =0V	900			V
Gate threshold voltage	V <sub>GS(th)</sub>	I <sub>D</sub> =250μA V <sub>DS</sub> =V <sub>GS</sub>	3.0		5.0	V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =900V V <sub>GS</sub> =0V			25	μA
		V <sub>DS</sub> =720V V <sub>GS</sub> =0V			250	
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =±30V V <sub>DS</sub> =0V			100	nA
Drain-source on-state resistance	R <sub>DS(on)</sub>	I <sub>D</sub> =5A V <sub>GS</sub> =10V		1.08	1.40	Ω
Forward transconductance	g <sub>fs</sub>	I <sub>D</sub> =5A V <sub>DS</sub> =25V	6	12		S
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V		1250	1900	pF
Output capacitance	C <sub>oss</sub>	V <sub>GS</sub> =0V		160	240	
Reverse transfer capacitance	C <sub>rss</sub>	f=1MHz		12	18	
Turn-on time t <sub>on</sub>	td(on)	V <sub>CC</sub> =600V I <sub>D</sub> =5A		26	39	ns
	t <sub>r</sub>	V <sub>GS</sub> =10V		23	35	
Turn-off time t <sub>off</sub>	td(off)	R <sub>GS</sub> =10 Ω		60	90	
	t <sub>f</sub>			17	26	
Total Gate Charge	Q <sub>G</sub>	V <sub>CC</sub> =450V		34.5	52	nC
Gate-Source Charge	Q <sub>GS</sub>	I <sub>D</sub> =10A		5	7.5	
Gate-Drain Charge	Q <sub>GD</sub>	V <sub>GS</sub> =10V		12	18	
Avalanche capability	I <sub>AV</sub>	L=6.06mH T <sub>ch</sub> =25°C	10			A
Diode forward on-voltage	V <sub>SD</sub>	I <sub>F</sub> =10A V <sub>GS</sub> =0V T <sub>ch</sub> =25°C		0.90	1.50	V
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> =10A V <sub>GS</sub> =0V		3.1		μs
Reverse recovery charge	Q <sub>rr</sub>	-di/dt=100A/μs T <sub>ch</sub> =25°C		17.0		μC

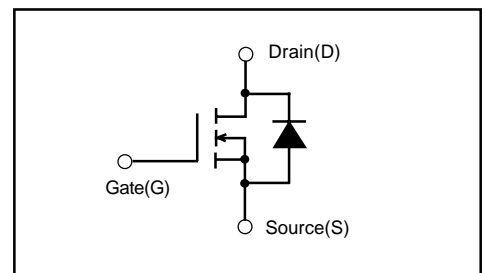
### ● Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	R <sub>th(ch-c)</sub>	channel to case			0.962	°C/W
	R <sub>th(ch-a)</sub>	channel to ambient			40.0	°C/W

### ■ Outline Drawings [mm]



### ■ Equivalent circuit schematic



Characteristics

